

SPECIFICATION FOR White LED

A0P7EFCKLNP4

- 0.5W maximum power capability
- Lead-free reflow soldering application
- Built-in ESD protection device
- RoHS compliant

Vendor		Customer
Written	Approval	Approval

Lumens CO., LTD.

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1. Product description

* Description

- The LED is designed for the high power operation to get the high flux output applications.
- It incorporates the state of the art SMD design and high reliable material.
- It is ideal for the light source for general illumination applications, custom designed solutions.

* Features

- Maximum drive current up to 150mA
- Low thermal resistance as low as 12 °C/W
- Wide viewing angle of 120 degrees
- Reflow soldering with JEDEC JSTD-020C compatible
- RoHS compliant

* Applications

- General luminaire
- Bulb
- Downlight

2. Absolute maximum ratings

Parameters	Symbol	Min Value	Max Value	Unit
Power dissipated	Pd		0.46	W
Rated forward current	If		150	mA
Allowable peak forward current(1)	Ip		200	mA
Maximum junction temperature capability	Tj		110	°C
Electrostatic discharge threshold(2)	ESD		±5,000	V
Operating temperature	Topr	-40	+85	°C
Storage temperature	Tstg	-40	+85	°C
Soldering temperature(Reflow)	Tsol		260°C, 10s	°C, s
Soldering temperature(Hand)	Tsoh		350°C, 3s	°C, s

(1) Ip measured at 1/10 duty cycle, 0.1ms pulse width.

(2) ESD HBM class 2 per Mil-Std-883D method 3015.

3. Electro-optical characteristics (Ta=25°C, If=65mA)

Parameters	Symbol	Condition	Min.	Typ.	Max.	Unit
Luminous Flux	Φ_v	If=65mA	23		31	lm
Correlated Color Temperature	CCT	If=65mA	2700		8000	K
Color Rendering Index	CRI	If=65mA		80		-
Forward voltage	Vf	If=65mA	2.8		3.1	V
Viewing angle FWHM	2 θ 1/2	If=65mA		120		deg
Thermal resistance junction to solder pad	Rthj-s			12		°C/W
Reverse voltage	Vr	If=10uA		0.6		V
Temperature coefficient Vf	TCv	If=65mA		-3		mV/°C

(1) Parameters are measured by CAS-140 of Instrument System CO.,LTD.

(2) Measurement accuracy : $\Phi_v(\pm 10\%)$, Vf($\pm 0.05V$).

4. Electro-optical chart

CCT(K)	If(mA)	Vf(V)	Pd(W)	Φ_v (lm)	lm/W
2700	60	2.900	0.174	25.15	144.6
	65	2.916	0.190	27.01	142.5
	120	3.092	0.371	46.23	124.6
	150	3.174	0.476	55.68	116.9
3000	60	2.943	0.177	25.94	146.9
	65	2.959	0.192	27.87	144.9
	120	3.137	0.376	47.69	126.7
	150	3.217	0.483	57.44	119.0
4000	60	2.943	0.177	27.26	154.4
	65	2.959	0.192	29.29	152.3
	120	3.137	0.376	50.32	133.7
	150	3.217	0.483	60.69	125.8
5000	60	2.912	0.175	28.27	161.8
	65	2.929	0.190	30.37	159.6
	120	3.101	0.372	51.98	139.7
	150	3.179	0.477	62.76	131.6
5700	60	2.912	0.175	27.82	159.2
	65	2.929	0.190	29.89	157.0
	120	3.101	0.372	51.15	137.5
	150	3.179	0.477	61.76	129.5
6500	60	2.912	0.175	27.25	156.0
	65	2.929	0.190	29.28	153.8
	120	3.101	0.372	50.11	134.7
	150	3.179	0.477	60.50	126.9

(1) Parameters are measured by CAS-140 of Instrument System CO.,LTD.

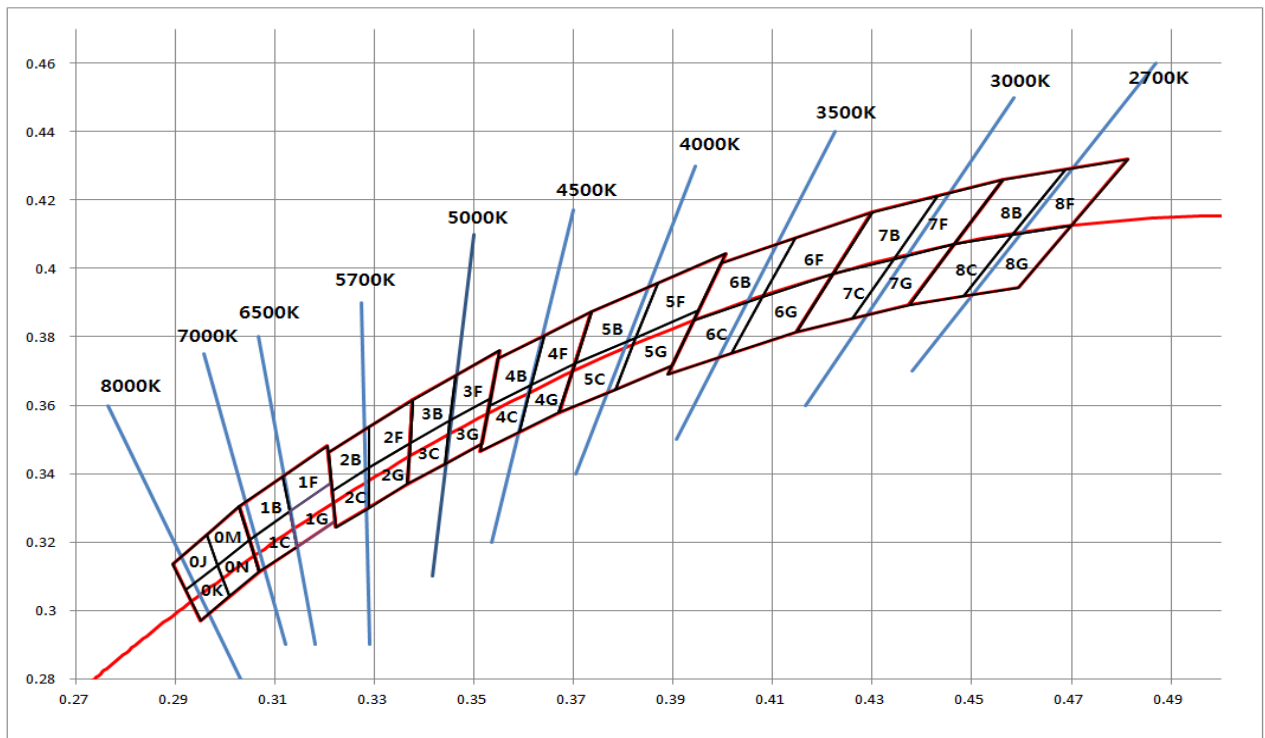
(2) Measurement accuracy : Φ_v ($\pm 10\%$), Vf($\pm 0.05V$).

5. Ranks

Item	Symbol	CCT(K)	Rank	Min.	Typ.	Max.	Unit	Condition
Luminous Flux	Φ_v	2700	A	23	-	25	lm	65mA
			B	25	-	27		
			C	27	-	29		
		3000	A	23	-	25	lm	
			B	25	-	27		
			C	27	-	29		
		4000	A	25	-	27	lm	
			B	27	-	29		
			C	29	-	31		
		5000	A	25	-	27	lm	
			B	27	-	29		
			C	29	-	31		
		5700	A	25	-	27	lm	
			B	27	-	29		
			C	29	-	31		
		6500	A	25	-	27	lm	
			B	27	-	29		
			C	29	-	31		
Forward Voltage	Vf	-	1	2.8	-	2.9	V	
			2	2.9	-	3.0		
			3	3.0	-	3.1		

- (1) Parameters are measured by CAS-140 of Instrument System CO.,LTD.
- (2) Measurement accuracy : $\Phi_v(\pm 10\%)$, $V_f(\pm 0.05V)$.

6. Chromaticity diagram



- (1) Chromaticity coordinate groups are measured with an accuracy of ± 0.01

7. Correlated Color Temperature Ranges

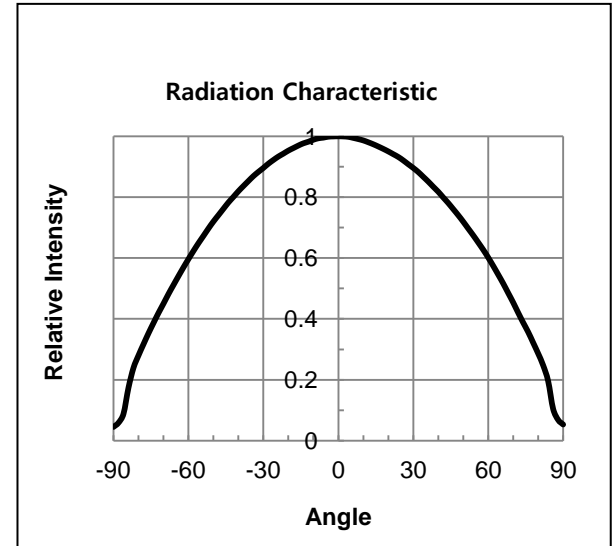
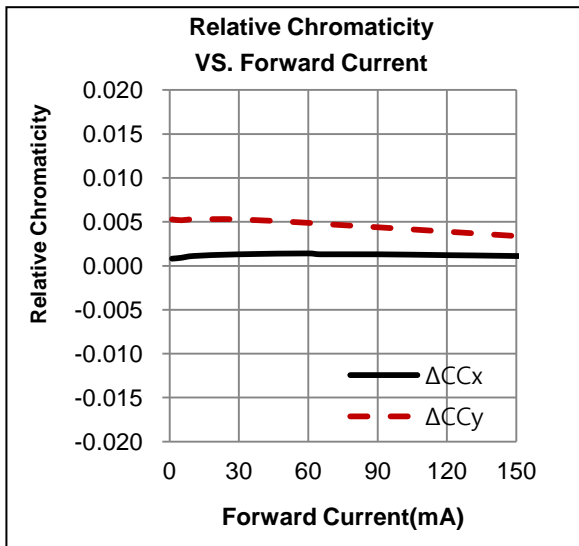
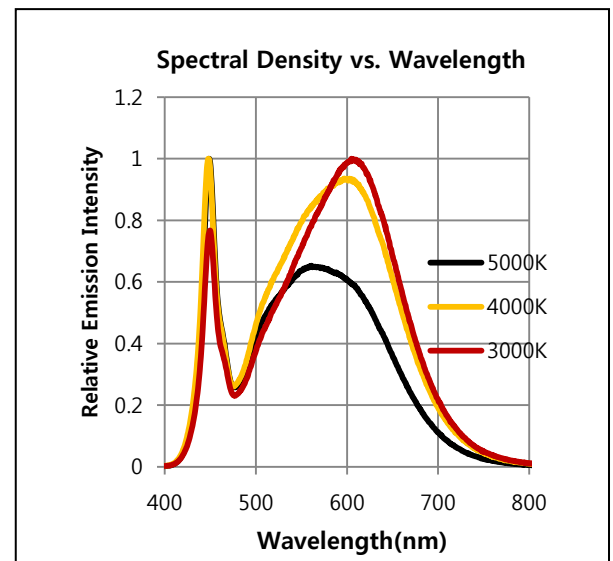
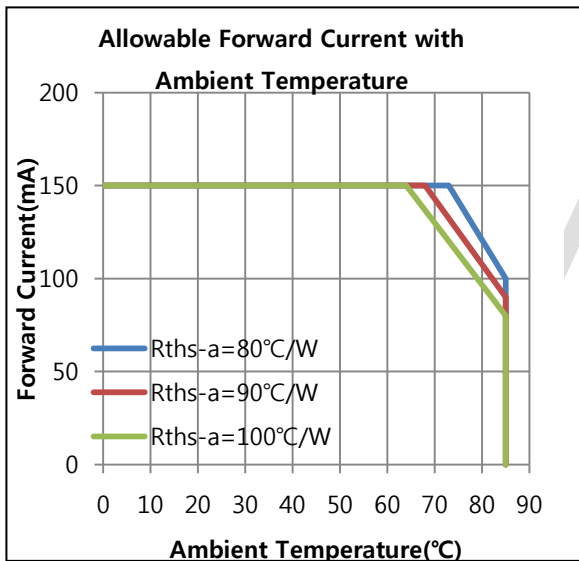
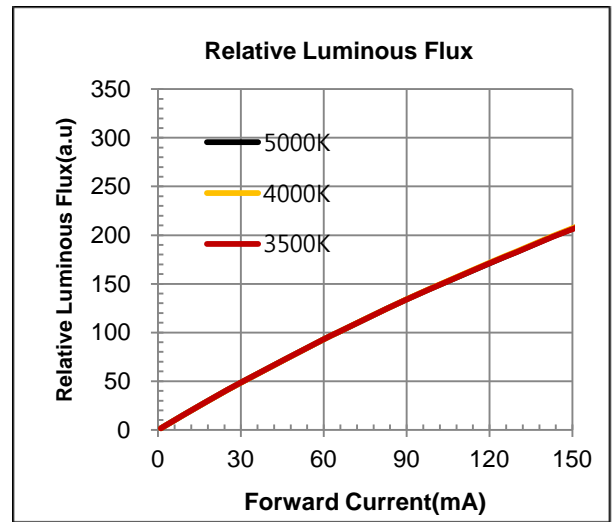
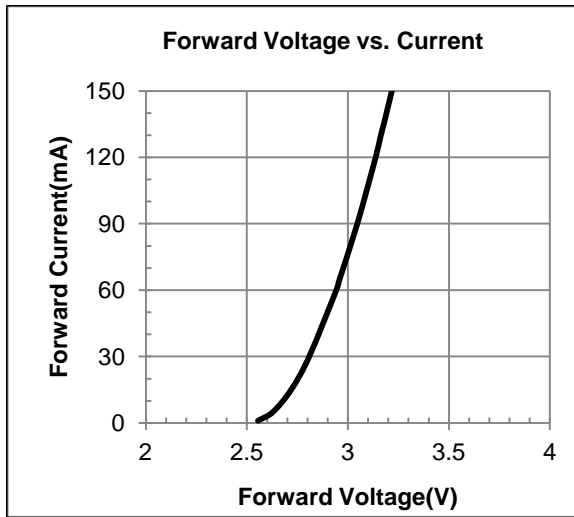
Item	CCT Ranges	CIE Ranges	Color bins
Cool-White	7000K ~ 5000K	1B ~ 3C	10bin
Neutral-White	5000K ~ 4000K	3F ~ 5C	8bin
Warm-White	4000K ~ 2600K	5F ~ 8G	14bin

8. Chromaticity coordinates

CCT	Rank	CIE X	CIE Y	CCT	Rank	CIE X	CIE Y	CCT	Rank	CIE X	CIE Y	CCT	Rank	CIE X	CIE Y		
6500K	1B	0.3028	0.3304	5000K	3B	0.3376	0.3616	4000K	5B	0.3736	0.3874	3000K	7B	0.4299	0.4165		
		0.3115	0.3391			0.3463	0.3687			0.3870	0.3958			0.4430	0.4212		
		0.3130	0.3290			0.3451	0.3554			0.3825	0.3798			0.4342	0.4028		
		0.3048	0.3207			0.3371	0.3490			0.3702	0.3722			0.4221	0.3985		
	0.3048	0.3207	0.3371		0.3490	0.3702	0.3722		0.4221	0.3985							
	1C	0.3130	0.3290		3C	0.3451	0.3554		5C	0.3825	0.3798		7C	0.4342	0.4028		
		0.3144	0.3186			0.3440	0.3427			0.3783	0.3646			0.4260	0.3853		
		0.3068	0.3113			0.3366	0.3369			0.3670	0.3578			0.4147	0.3814		
		0.3115	0.3391			0.3463	0.3687			0.3870	0.3958			0.4430	0.4212		
	1F	0.3205	0.3481		3F	0.3551	0.3760		5F	0.4006	0.4044		7F	0.4562	0.4260		
		0.3213	0.3373			0.3533	0.3620			0.3951	0.3876			0.4465	0.4071		
		0.3130	0.3290			0.3451	0.3554			0.3825	0.3798			0.4342	0.4028		
		0.3213	0.3373			0.3533	0.3620			0.3951	0.3876			0.4465	0.4071		
	1G	0.3221	0.3261		3G	0.3515	0.3487		5G	0.3898	0.3716		7G	0.4373	0.3893		
		0.3144	0.3186			0.3440	0.3427			0.3783	0.3646			0.4260	0.3853		
		0.3207	0.3462			4500K	4B			0.3548	0.3736			3500K	6B	0.3996	0.4015
0.3290		0.3538	0.3641	0.3804				0.4146		0.4089	0.4687	0.4289					
0.3290	0.3417	0.3615	0.3659	0.4080	0.3916			0.4582	0.4099								
0.3215	0.3350	0.3530	0.3597	0.3941	0.3848			0.4465	0.4071								
2C	0.3215	0.3350	4C	0.3530	0.3597		6C	0.3941	0.3848	8C	0.4465	0.4071					
	0.3290	0.3417		0.3615	0.3659			0.4080	0.3916		0.4582	0.4099					
	0.3290	0.3300		0.3590	0.3521			0.4017	0.3752		0.4483	0.3918					
	0.3222	0.3243		0.3512	0.3465			0.3889	0.3690		0.4373	0.3893					
2F	0.3290	0.3538	4F	0.3641	0.3804		6F	0.4146	0.4089	8F	0.4687	0.4289					
	0.3376	0.3616		0.3736	0.3874			0.4299	0.4165		0.4813	0.4319					
	0.3371	0.3490		0.3702	0.3722			0.4221	0.3985		0.4700	0.4126					
	0.3290	0.3417		0.3615	0.3659			0.4080	0.3916		0.4582	0.4099					
2G	0.3290	0.3417	4G	0.3615	0.3659		6G	0.4080	0.3916	8G	0.4582	0.4099					
	0.3371	0.3490		0.3702	0.3722			0.4221	0.3985		0.4700	0.4126					
	0.3366	0.3369		0.3670	0.3578			0.4147	0.3814		0.4593	0.3944					
	0.3290	0.3300		0.3590	0.3521			0.4017	0.3752		0.4483	0.3918					

(1) Chromaticity coordinate groups are measured with an accuracy of ±0.01

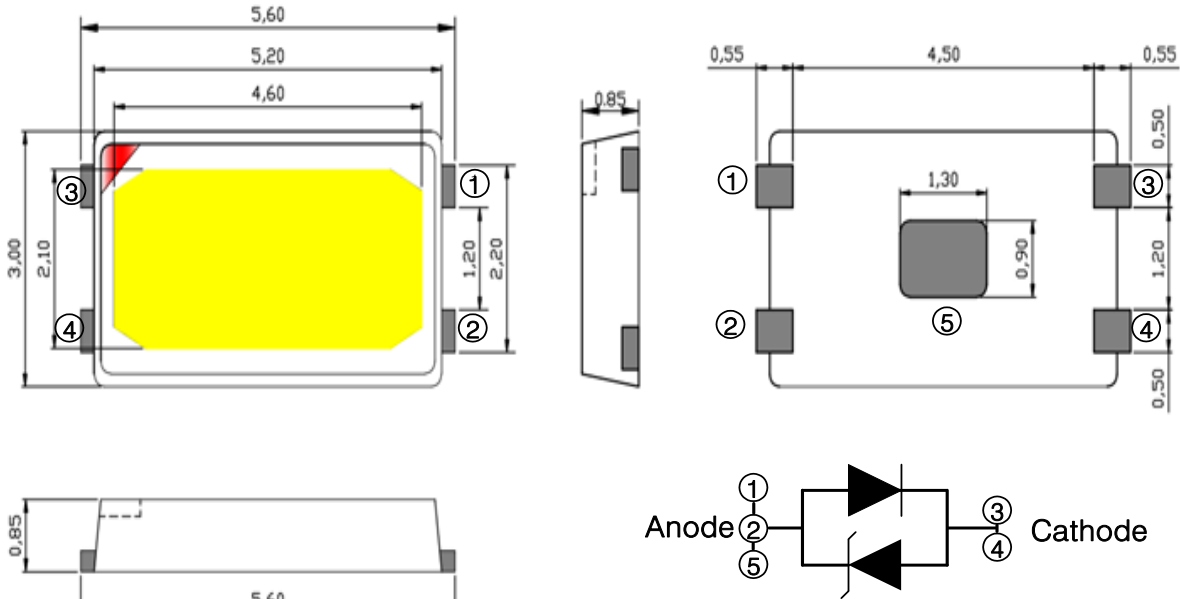
9. Characteristic Graphs(Ta=25°C)



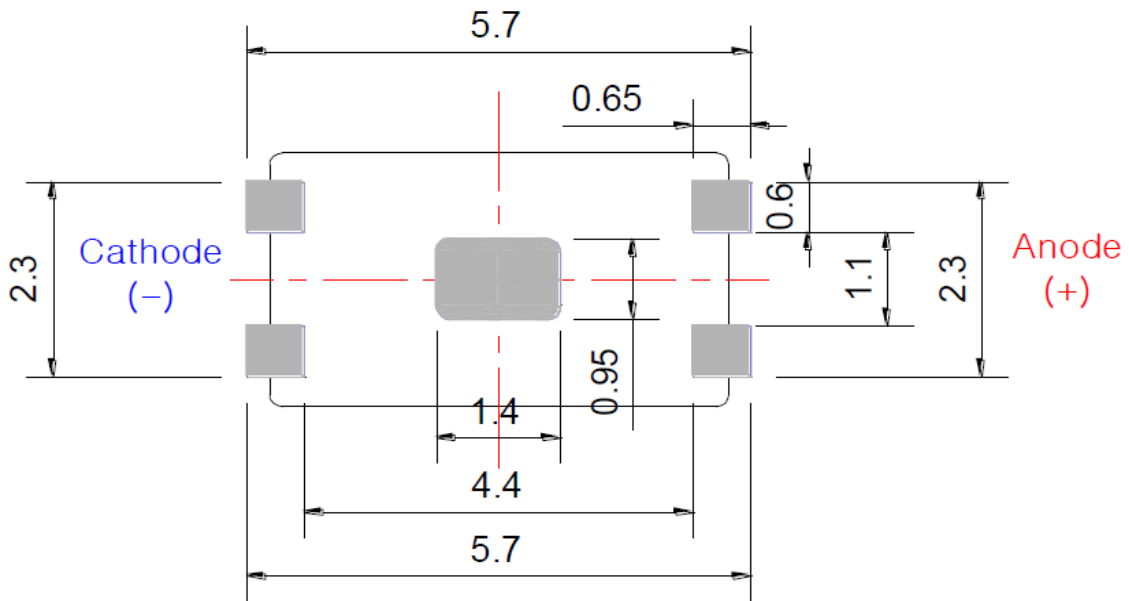
10. Outline Dimensions

Unit : mm

- 1) Package outline : (LxWxH) of 5.6 x 3.0 x 0.85 mm.
- 2) Tolerance - All measurements are ± 0.15 mm unless otherwise indicated.



11. Recommended solder pad



(Unit : mm)

12. Reliability test items and conditions

Item	Reference	Test Conditions	Duration / Cycle	Number of Damaged
Thermal Shock	EIAJ ED-4701	Ta = -40°C (30min) ~ 100°C (30min)	150 Cycle	0/30
Operating Endurance Test	Internal Reference	Ta = 25°C, IF = 150mA	1000 Hours	0/30
High Temperature High Humidity Life Test	Internal Reference	Ta = 60°C, RH=90%, IF = 150mA	500 Hours	0/30
High Temperature Life Test	Internal Reference	Ta = 85°C, IF = 90mA	500 Hours	0/30
ESD(HBM)		±5KV at 1.5kΩ, 100pF	5 Time	0/5
Reflow	Tsor	260°C < 10sec, Reflow Soldering	3 Time	0/30

- Test Board : Metal board thickness=1.6mm, Copper layer thickness=0.07mm, Rth ≈100 °C/W

◆ CRITERIA FOR JUDGING THE DAMAGE

Item	Symbol	Condition	Criteria for Judgment	
			MIN	MAX
Forward Voltage	Vf	IF = 65mA	-	USL (1) × 1.1
Luminous Flux	Φv	IF = 65mA	LSL (2) × 0.7	-

(1) USL : Upper Standard Level

(2) LSL : Lower Standard Level

13. Recommended soldering temperature – time profile for reflow soldering

Surface Mounting Condition

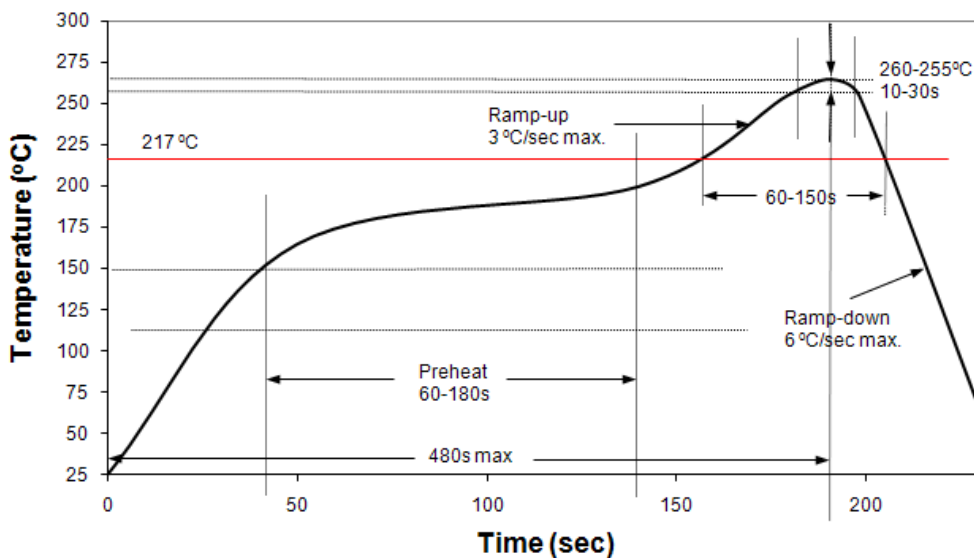
In automatic mounting of the SMD LEDs on printed circuit boards, any bending, expanding and pulling forces or shock against the SMD LEDs should be kept minimum to prevent them from electrical failures and mechanical damages of the devices.

Soldering Reflow

- Soldering of the SMD LEDs should conform to the soldering condition in the individual specifications.
- SMD LEDs are designed for reflow soldering.
- In the reflow soldering, too high temperature and too large temperature gradient such as rapid heating/cooling may cause electrical & optical failures and damages of the devices.
- Lumens cannot guarantee the LEDs after they have been assembled using the solder dipping method.

Recommended Pb Free IR-Reflow Soldering Profile.

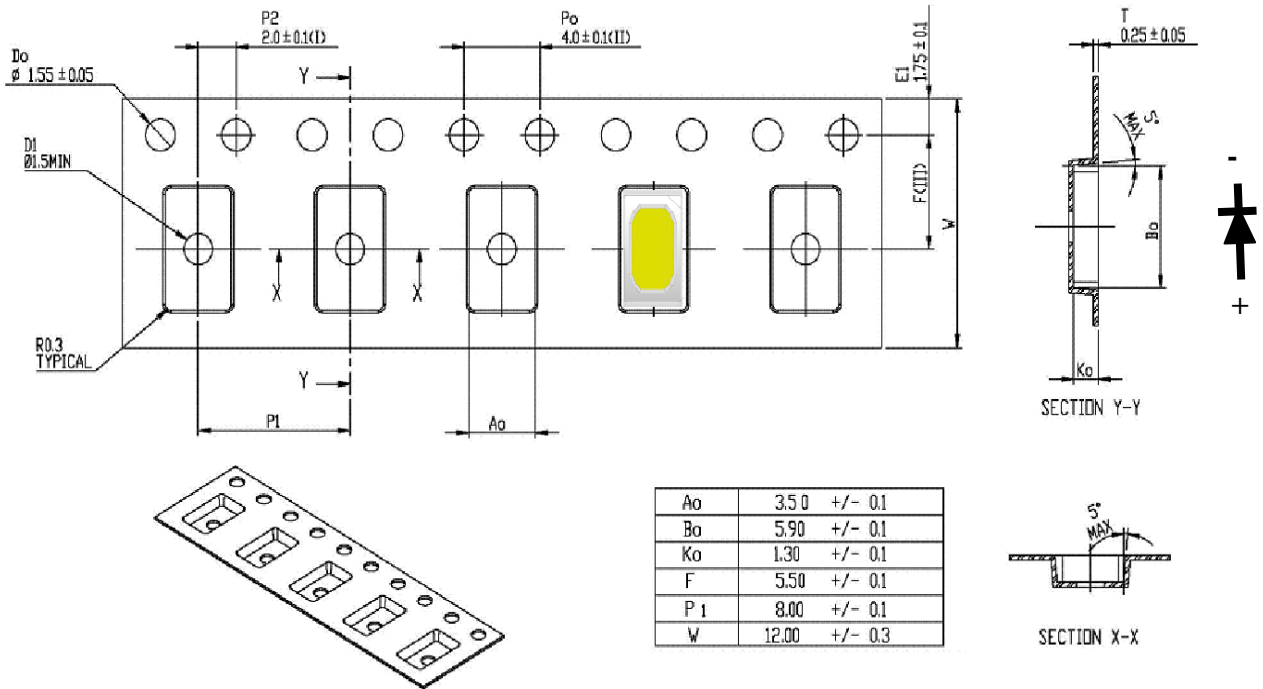
Classification Reflow Profile (JEDEC J-STD-020C)



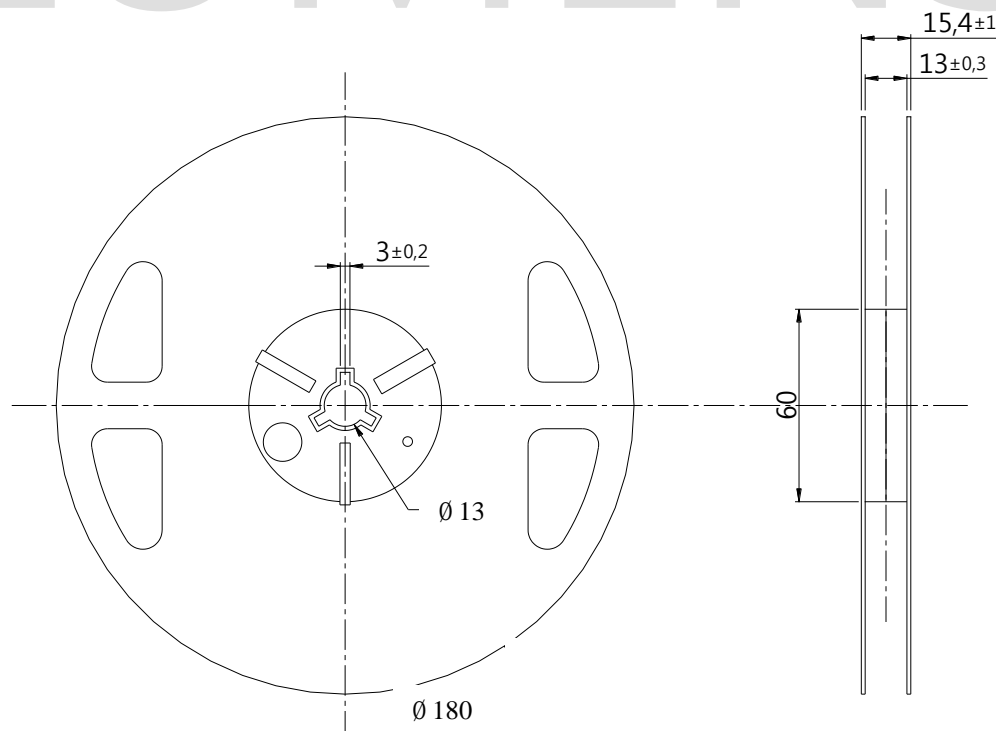
14. Taping and orientation

1. Moisture proof bag.
2. 1 Reel/bag.
3. Quantity : 3000ea/Reel.

<Carrier tape Dimension>



<Reel Dimension>



15. Cautions

- 1 Moisture-Proof Package
 - 1.1 When moisture is absorbed into the LED package it may vaporize and expand products during soldering. There is a possibility that this may cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture-proof package is used to keep moisture to a minimum in the package.
 - 1.2 A package of a moisture-absorbent material (silica gel) is inserted into the shielding bag. The silica gel changes its color from blue to pink as it absorbs moisture.
- 2 Current limiting

A resistor should be used to limit current spikes that can be caused by voltage fluctuations. Otherwise damage could occur.
- 3 Iron Soldering
 - 3.1 Hand soldering is not recommended for regular production. These guidelines are for rework only.
 - 3.2 Soldering iron tip should contact each terminal no more than 3 sec at 120°C, using soldering iron with nominal power less than 25W. Allow min. 2 sec. between soldering intervals.
- 4 Storage Conditions
 - 4.1 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture-proof packaging with moisture-absorbent material (silica gel) is recommended.
 - 4.2 After opening the package: The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, they should be stored in moisture-proof packages, such as sealed containers with packages of moisture-absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture-proof bag and to reseal the moisture-proof bag again.
 - 4.3 If the moisture-absorbent material (silica gel) has faded away or the LEDs have exceeded the recommended storage time, baking treatment should be performed using the following conditions. Baking treatment: more than 24 hours at 65±5°C
 - 4.4 Lumens LED electrode sections are comprised of a silver-plated copper alloy. The silver surface may be affected by environments which contain corrosive gases and so on. Please avoid condition which may cause difficulty environments during soldering operations. It is recommended that the user uses the LEDs as soon as possible.
 - 4.5 Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.
- 5 Handling of Silicone Lens LEDs
 - 5.1 Avoid silicone resin parts especially with sharp tools such as pincette(tweezers).
 - 5.2 Avoid leaving fingerprints on silicone lens part.
 - 5.3 Do not apply the silicone lens part with pressure especially in SMT production. So use a proper nozzle not to press the lens part of the LED to pick and place.
- 6 Usage
 - 6.1 Do not exceed the values given in this specification.

NOTE :

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